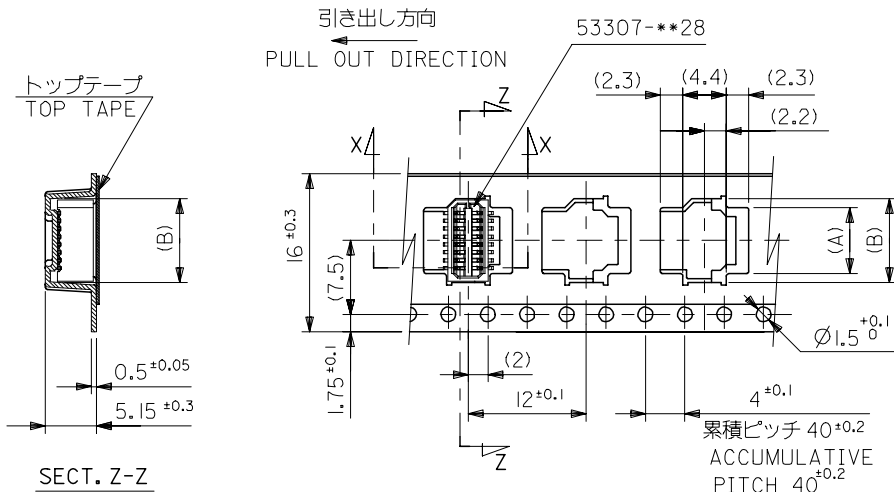
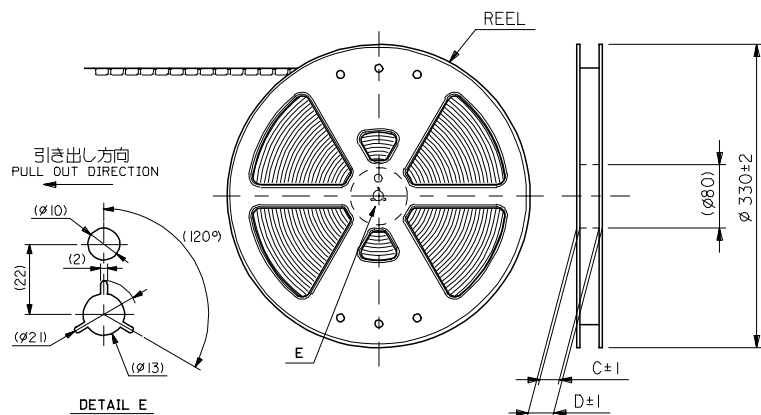
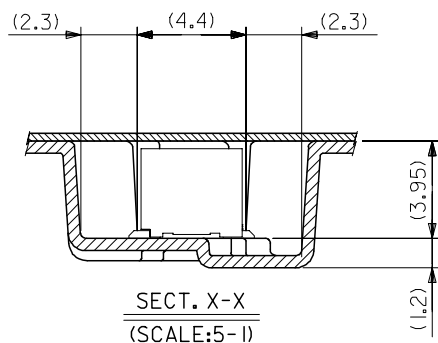




SECT. Z-Z



注記 NOTES

1. 梱包数量: 1000個/リール NUMBER OF CONNECTORS: 1000PCS/REEL

2. リードテープ長さ LEAD TAPE LENGTH

トップテープ リーダー部 TOP TAPE LEADER PART
トップテープ 未接着部 TOP TAPE NON-BONDED PART

175±25 25±5

引き出し方向
PULL OUT DIRECTION



3. トップテープの剥離強度: (剥離方向は下図参照)

0.1N~1.3N (10gf~130gf)

尚、本規格値は、出荷時に適用。

(但し、輸送時に剥離が発生しない事。)

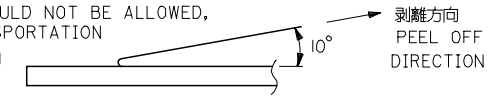
PEELING OFF FORCE OF TOP TAPE

0.1N~1.3N (10gf~130gf) (PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)

THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT

PEEL OFF SHOULD NOT BE ALLOWED, DURING TRANSPORTATION

引き出し方向
PULL OUT DIRECTION



4. 材料

キャリアテープ: ポリプロピレン (PP)

トップテープ: PET, PE, PEF

リール: ポリスチレン (PS)

<リサイクル材を含む>

MATERIAL
CARRIER TOP

TAPE: POLYPROPYLENE

TAPE: PET, PE, PEF

REEL: POLYSTYRENE (PS)

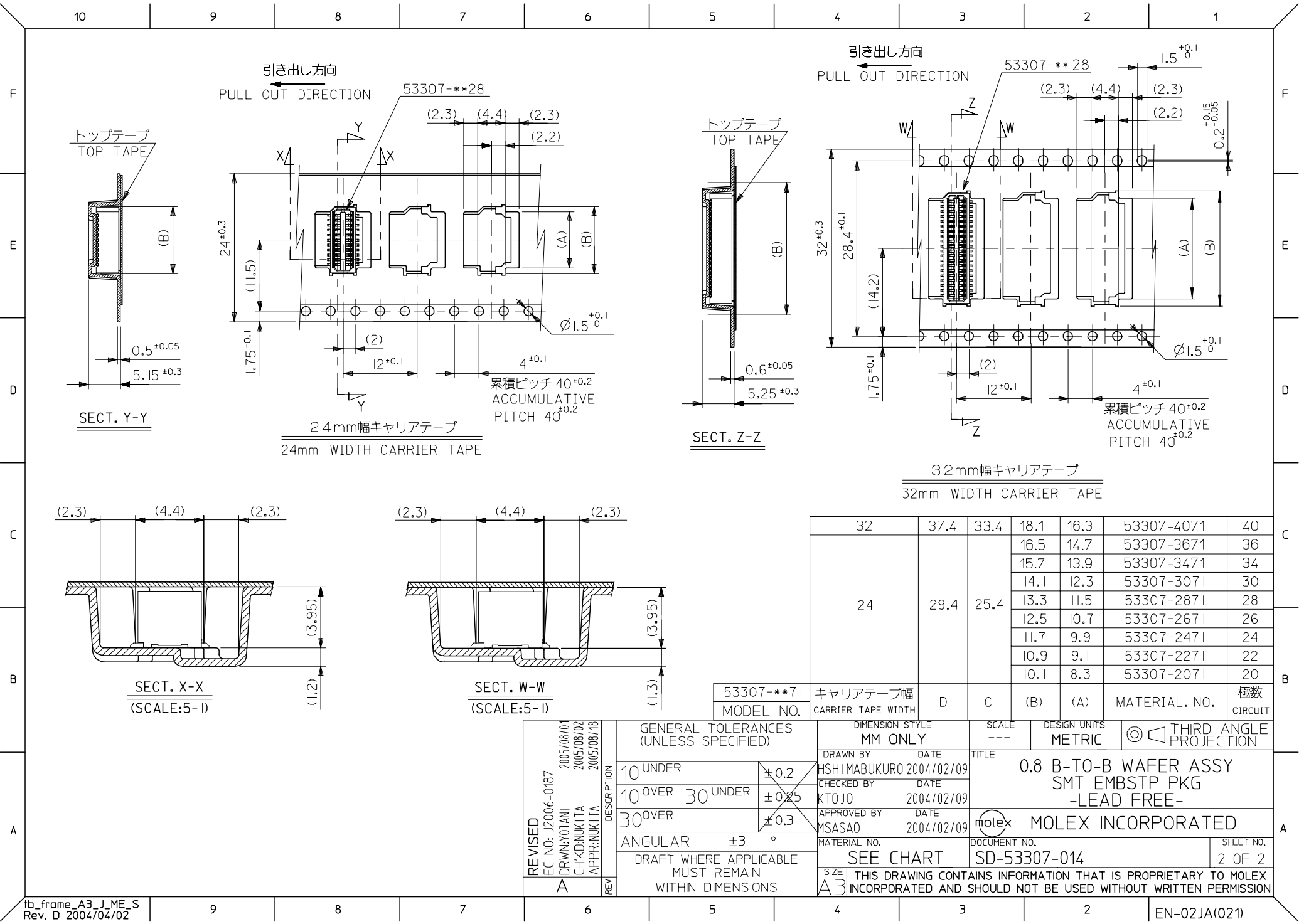
<RECYCLE MATERIAL CONTAINED>

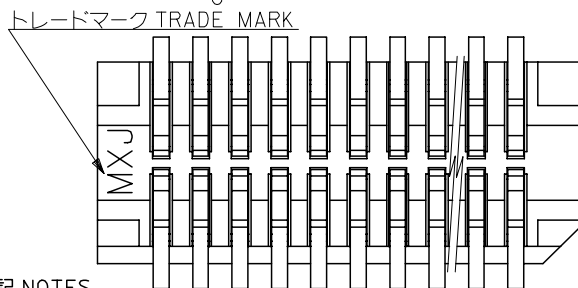
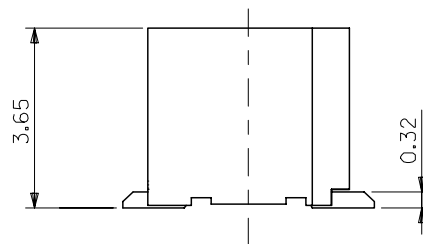
5. 本製品は 53307-***91 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 53307-***91

53307-***91 MODEL NO.	キャリアテープ幅 CARRIER TAPE WIDTH	D	C	(B)	(A)	MATERIAL NO.	極数 CIRCUIT
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16	21.4	17.4	9.3	7.5	53307-1871	18
			8.5	6.7	53307-1671	16
			7.7	5.9	53307-1471	14
			6.9	5.1	53307-1271	12
			6.1	4.3	53307-1071	10

REVISED EC NO: J2006-0187 DRAWN: YOTANI CHKD: NUKITA APPR: NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2 ±0.25 ±0.3	DRAWN BY	DATE	TITLE 0.8 B-TO-B WAFER ASSY SMT EMBSTP PKG -LEAD FREE-				
		10 OVER 30 UNDER		CHECKED BY	DATE					
		30 OVER		APPROVED BY	DATE	MOLEX INCORPORATED				
		ANGULAR ±3 °	MATERIAL NO.	DOCUMENT NO.	SHEET NO.					
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-53307-014				
A	REV	SIZE A3 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								





注記 NOTES

1. 嵌合相手：52465,52588
MATE WITH : 52465,52588 SERIES
△ ウエハの ㊦ から隣接するピン の ㊦ 迄の位置を示す。
SHOW POSITION FROM ㊦ OF WAFER TO ㊦ OF ADJACENT PINS.
3 本製品は 53307-**27 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 53307-**27

ピン PIN

[F] (リン青銅、錫メッキ、
ニッケル下地 t=0.32)

[H] (PHOS-BRO. TIN LO MICROMETER MIN. OVER
NICKEL UNDER PLATING) LO MICROMETER MIN.
t=0.32)

回路番号 1 (表示用切欠き)

CHAMFERING TO
INDICATE CKT. NO.1

+0.05
-0.01

SECT. G-G

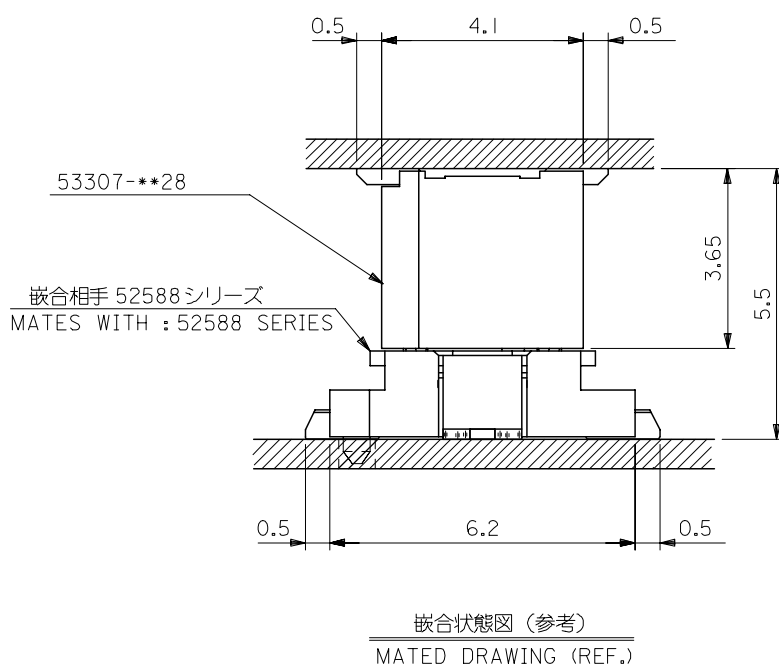
コネクタ位
CONNECTOR
POSITION

参考基板レイアウト（マウント面）

P.C.B. PATTERN LAYOUT (REF.) (MOUNT AREA)

0.4	17.8	16.9	15.2	53307-4028	40
0.8	17.0	16.1	14.4	-3828	38
0.4	16.2	15.3	13.6	-3628	36
0.8	15.4	14.5	12.8	-3428	34
0.4	14.6	13.7	12.0	-3228	32
0.8	13.8	12.9	11.2	-3028	30
0.4	13.0	12.1	10.4	-2828	28
0.8	12.2	11.3	9.6	-2628	26
0.4	11.4	10.5	8.8	-2428	24
0.8	10.6	9.7	8.0	-2228	22
0.4	9.8	8.9	7.2	-2028	20
0.8	9.0	8.1	6.4	-1828	18
0.4	8.2	7.3	5.6	-1628	16
0.8	7.4	6.5	4.8	-1428	14
0.4	6.6	5.7	4.0	-1228	12
0.8	5.8	4.9	3.2	53307-1028	10
D	C	B	A	MATERIAL. NO.	極數 CKT.

REVISED	EC NO: J2006-1257 DRAWN: YOTANI CHKD: NUKITA APPR: NUKITA	2005/10/25 2005/10/25 2005/10/31	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
				10 UNDER	± 0.2	DRAWN BY DATE HSH1 MABUKURO 2004/02/09		TITLE 0.8 B/B CONN WAFER ASSY ST SMT (SHEET 1 OF 2) -LEAD FREE-			
				10 OVER 30 UNDER	± 0.25	CHECKED BY DATE KTOJO 2004/02/09					
				30 OVER	± 0.3	APPROVED BY DATE MSASAO 2004/02/09		MOLEX INCORPORATED			
				ANGULAR ±3 °		MATERIAL NO.					
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-53307-015		1 OF 2	
			REV			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



tb_frame_A3_J_ME_S
Rev. D 2004/04/02